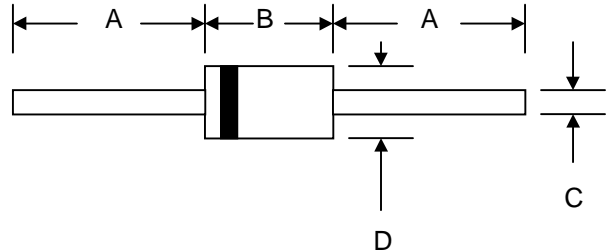


Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability



Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 1.2 grams (approx.)
- Mounting Position: Any
- Marking: Type Number
- **Lead Free: For RoHS / Lead Free Version**

DO-201AD		
Dim	Min	Max
A	24.5	—
B	7.20	9.50
C	1.10	1.30
D	5.00	5.60
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	31DF4	31DF6	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	400	600	V
Working Peak Reverse Voltage	V_{RWM}			
DC Blocking Voltage	V_R			
RMS Reverse Voltage	$V_{R(RMS)}$	280	420	V
Average Rectified Output Current (Note 1)	I_O	3.0		A
		@ $T_A = 55^\circ\text{C}$		
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	45		A
Forward Voltage	V_{FM}	1.70		V
		@ $I_F = 3.0\text{A}$		
Peak Reverse Current	I_{RM}	5.0		μA
At Rated DC Blocking Voltage		100		
		@ $T_A = 25^\circ\text{C}$		
		@ $T_A = 100^\circ\text{C}$		
Reverse Recovery Time (Note 2)	t_{rr}	35		nS
Typical Junction Capacitance (Note 3)	C_j	80		pF
Operating Temperature Range	T_j	-65 to +150		$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150		$^\circ\text{C}$

- Note: 1. Leads maintained at ambient temperature at a distance of 9.5mm from the case
2. Measured with $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $IRR = 0.25\text{A}$. See figure 5.
3. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

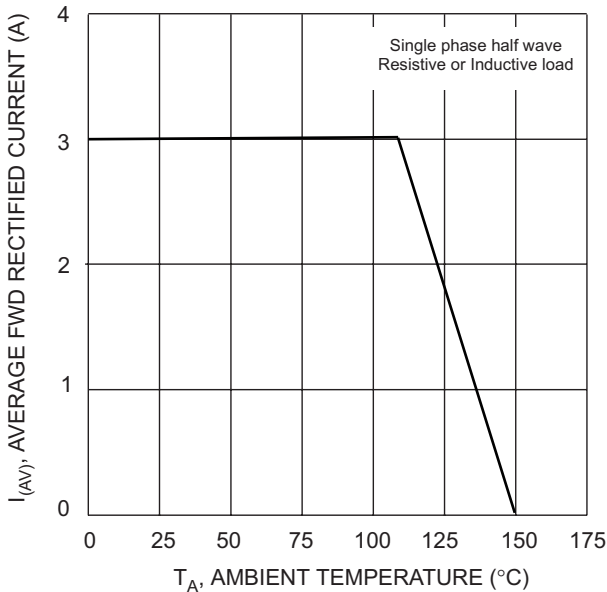


Fig. 1 Forward Current Derating Curve

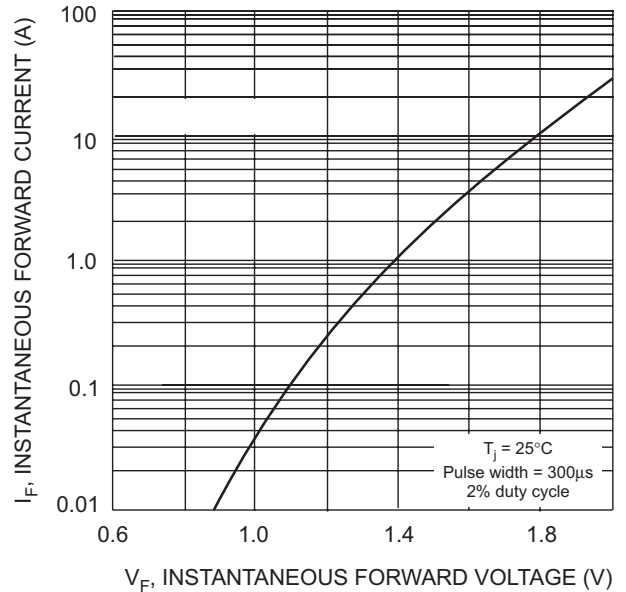


Fig. 2 Typical Forward Characteristics

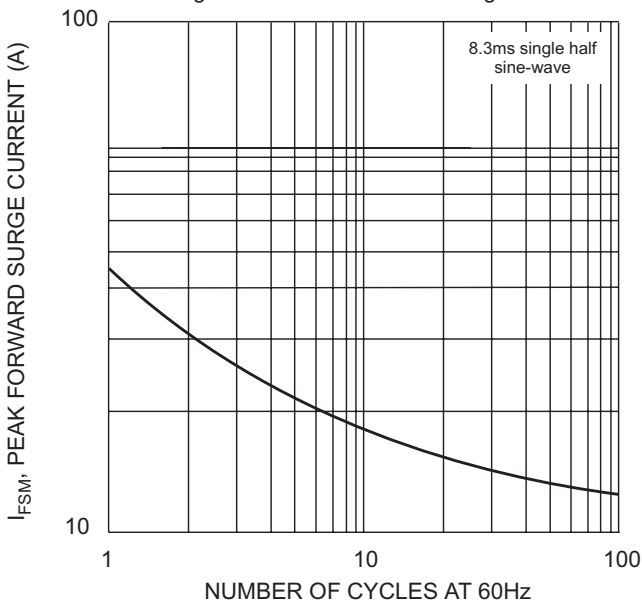


Fig. 3 Peak Forward Surge Current

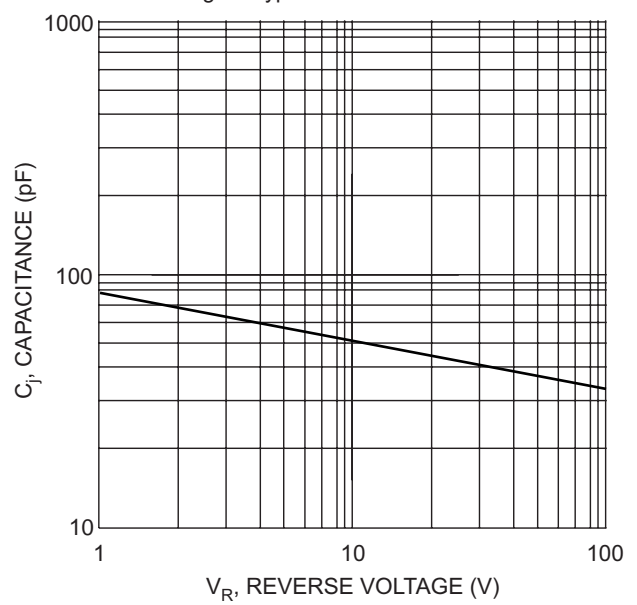
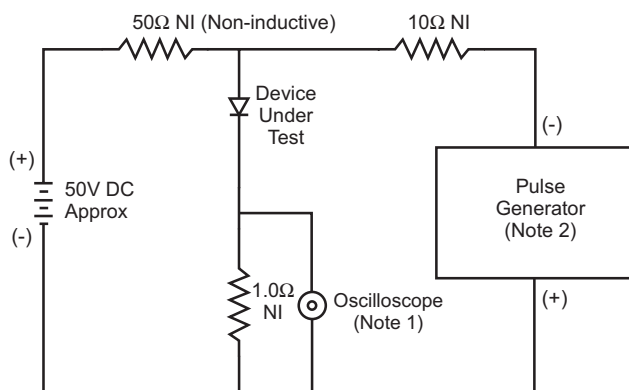


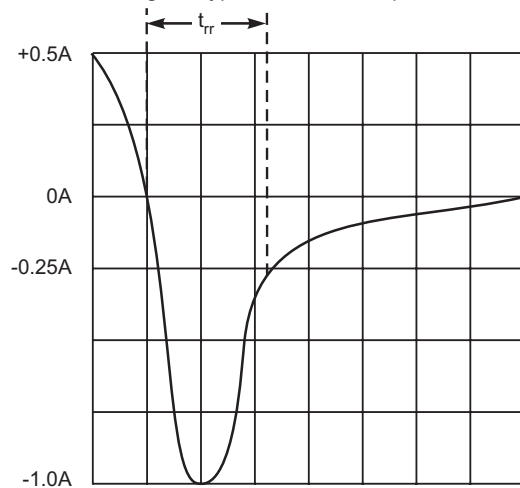
Fig. 4 Typical Junction Capacitance



Notes:

1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
2. Rise Time = 10ns max. Input Impedance = 50Ω.

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Set time base for 5/10ns/cm